

This is a preview - click here to buy the full publication

INTERNATIONAL STANDARD

**ISO/IEC
14536**

**ANSI/IEEE
Std 896.5**

First edition
1995-12-29

**Information technology –
Microprocessor systems –
Futurebus+™, Profile M (military)**

*Technologies de l'information –
Systèmes à microprocesseurs –
Futurebus+™, Profil M (militaire)*

Without
Copyright



Reference number
ISO/IEC 14536: 1995(E)
ANSI/IEEE
Std 896.5, 1995 Edition

Abstract: This International Standard provides a set of tools with which to implement a Futurebus+™ achitecture. This high-performance bus-based system architecture provides a wide range of performance and cost scalability over time for multiple generations of single- and multiple-bus multiprocessor systems. This document, a companion standard to ISO/IEC 10857:1994 [ANSI/IEEE Std 896.1, 1994 Edition], builds on the logical layer by adding requirements for three military profiles. It is to these profiles that products will claim conformance. Other specifications that may be required in conjunction with this International Standard are [ISO/IEC Std 10857:1994 [ANSI/IEEE Std 896.1, 1994 Edition], IEEE Std 896.2-1991, IEEE Std 896.2a-1994, IEEE Std 896.3-1993, IEEE Std 896.4-1993, IEEE P896.4a, IEEE Std 896.9-1994, IEEE Std 1101.3-1993, IEEE Std 1101.4-1993, IEEE Std 1212-1991, IEEE Std 1194.1-1991, IEEE P1394, IEEE Std 1301-1991, and IEEE Std 1301.1-1991.

Keywords: bus architecture, error logging, fault logging, Futurebus+, live insertion, military profiles, multiprocessor systems, node management, open architecture, Serial Bus, software debug

The Institute of Electrical and Electronics Engineers, Inc.
345 East 47th Street, New York, NY 10017-2394, USA

Copyright © 1995 by the Institute of Electrical and Electronics Engineers, Inc.
All rights reserved. Published 1995. Printed in the United States of America

ISBN 1-55937-539-6

No part of this publication may be reproduced in any form, in an electronic retrieval system or otherwise, without the prior written permission of the publisher.

December 29, 1995

SH94303

ISO/IEC 14536 : 1995
[ANSI/IEEE Std 896.5, 1995 Edition]
(Incorporates ANSI/IEEE Std 896.5-1993 and IEEE Std 896.5a-1994)

Information technology— Microprocessor systems— Futurebus+™, Profile M (Military)

Sponsor

Bus Architecture Standards Committee
of the
IEEE Computer Society



Adopted as an International Standard by the
International Organization for Standardization
and by the
International Electrotechnical Commission



Published by
The Institute of Electrical and Electronics Engineers, Inc.



Foreword

ISO (the International Organization for Standardization) and IEC (the International Electrotechnical Commission) form the specialized system for worldwide standardization. National bodies that are members of ISO or IEC participate in the development of International Standards through technical committees established by the respective organization to deal with particular fields of technical activity. ISO and IEC technical committees collaborate in fields of mutual interest. Other international organizations, governmental and nongovernmental, in liaison with ISO and IEC, also take part in the work.

In the field of information technology, ISO and IEC have established a joint technical committee, ISO/IEC JTC 1. Draft International Standards adopted by the joint technical committee are circulated to national bodies for voting. Publication as an International Standard requires approval by at least 75% of the national bodies casting a vote.

In 1995, ANSI/IEEE Std 896.5-1993, together with IEEE Std 896.5a-1994, *Errata, Corrections, and Clarifications*, was adopted by ISO/IEC JTC 1, as draft International Standard ISO/IEC DIS 14536:1995. This edition incorporates IEEE Std 896.5a-1994 into the text of ANSI/IEEE Std 896.5-1993.



IEEE Standards documents are developed within the Technical Committees of the IEEE Societies and the Standards Coordinating Committees of the IEEE Standards Board. Members of the committees serve voluntarily and without compensation. They are not necessarily members of the Institute. The standards developed within IEEE represent a consensus of the broad expertise on the subject within the Institute as well as those activities outside of IEEE that have expressed an interest in participating in the development of the standard.

Use of an IEEE Standard is wholly voluntary. The existence of an IEEE Standard does not imply that there are no other ways to produce, test, measure, purchase, market, or provide other goods and services related to the scope of the IEEE Standard. Furthermore, the viewpoint expressed at the time a standard is approved and issued is subject to change brought about through developments in the state of the art and comments received from users of the standard. Every IEEE Standard is subjected to review at least every five years for revision or reaffirmation. When a document is more than five years old and has not been reaffirmed, it is reasonable to conclude that its contents, although still of some value, do not wholly reflect the present state of the art. Users are cautioned to check to determine that they have the latest edition of any IEEE Standard.

Comments for revision of IEEE Standards are welcome from any interested party, regardless of membership affiliation with IEEE. Suggestions for changes in documents should be in the form of a proposed change of text together with appropriate supporting comments.

Interpretations: Occasionally questions may arise regarding the meaning of portions of standards as they relate to specific applications. When the need for interpretations is brought to the attention of IEEE, the Institute will initiate action to prepare appropriate responses. Since IEEE Standards represent a consensus of all concerned interests, it is important to ensure that any interpretation has also received the concurrence of a balance of interests. For this reason IEEE and the members of its technical committees are not able to provide an instant response to interpretation requests except in those cases where the matter has previously received formal consideration.

Comments on standards and requests for interpretations should be addressed to:

Secretary, IEEE Standards Board
445 Hoes Lane
P.O. Box 1331
Piscataway, NJ 08855-1331
USA

IEEE standards documents may involve the use of patented technology. Their approval by the Institute of Electrical and Electronics Engineers, Inc. does not mean that using such technology for the purpose of conforming to such standards is authorized by the patent owner. It is the obligation of the user of such technology to obtain all necessary permissions.

Introduction

[This introduction is not a normative part of ISO/IEC 14536 : 1995, but is included for information only.]

IEEE Std 896.5-1993, IEEE Standard for Futurebus+,™ Profile M (Military) culminates a several year effort to define a standard for military use of Futurebus+. It is the result of the combined efforts of a large number of people in industry and in government who felt that the military should adapt commercial standards rather than invent its own. In the adaptation process, special consideration was given to military needs in the following areas: a) harsh environments, b) real time usage, c) security, d) reliability and fault tolerance, e) testing and maintenance, f) software debugging and system integration, and g) analog/RF components. This standard intends to meet these needs.

At the time this standard was completed, the P896.5 Working Group had the following membership:

Ralph Lachenmaier, *Chair*

Cory Ackerman	John Franz	Peter Onufryk
Ray Alderman	Richard Fryer	Bill Panter
Duane Anderson	Gary Gardner	Anthony Pascuzzi
Harry Andreas	John Griffith	Grish Patel
Harrison Beasley	Dave Gustavson	Thomas Potyraj
John Bolton	Emil Hahn	Bill Rigby
Andy Bonaffini	Mark Hassel	Ken Ristow
David Brearly	David Hollenbeck	Michael Roby
John Brightwell	Mike Humphrey	Ed Rodriguez
Andrew Brough	Tim Iacono	Frederick Sauer
Jim Brown	Edgar Jacques	Atlant Schmidt
Mark Bunker	David James	William Schneider
Jay Cantrell	Anatol Kaganovich	Lui Sha
Andrew Capobianco	Mark Karan	Gene Schramm
John Campbell	Rangesh Kasturi	Don Senzig
Robert Carpenter	Bruce Kimble	James Simon
Keith Cavis	David Kirk	Adam Simonoff
Stephen Cecii	James Koser	Dennis Smith
Charles Cheatwood	M. Raj Kumar	Patricia Smith
Karen Churas	Dan Kuyper	Mike Snodgrass
Terry Clayton	Ben LaPointe	Joanne Spiller
Kim Clohessy	Mike Lambrou	Vincent Squitieri
Paul Cook	Jeff Lear	Daniel Tarrant
Al Corda	Jim Lockwood	Thomas Tate
Ernest Crocker	Jim Madison	Lars Thernsjo
Paul Dixon	Ernest Mardage	John Theus
Mike Dorsett	Joel Martinez	Michael Thompson
Frank Duffy	Karl McClure, Jr.	Matthew Ting
Samuel Duncan	Fenton McDonald	Joseph Toy
Bruce Dunlop	Jim Moidel	Joe Trainor
Mike Ebl	Brian Morrison	Dean Van De Walker
Duane Embrce	Michael Munroe	Robert Voigt
Wilhelm Evertz	Jerry Murdock	Tom Vrankar
Robert Fluhrer	George Nacht	Kirk Wheeler
Mike Foster	Robert Naville	Joel Witt
	Eric Nickerson	

The following persons were on the balloting committee:

Amir Abouelnaga
Edward W. Aichinger
Ray Alderman
Harry Andreas
Keith D. Anthony
Harrison Beasley
Donald Bennett
Chris Bezirtzoglou
Andrew Brough
Scott Buck
Kim Clohessy
Steven Cobb
Robert Crowder
Doug Degroot
Mike Dorsett
Samuel Duncan
Bruce Dunlop
Wilhelm Evertz
Wayne Fischer
Robert Fluhrer

Richard Fryer
Joseph D. George
Julio Gonzalez-Sanz
John Griffith
Mark Hassel
Zoltan R. Hunor
Edgar Jacques
David James
Jeffrey A. Jaska
Horace Jones
David Kirk
Ernst H. Kristiansen
Ralph Lachenmaier
Lak Ming Lam
Boon Lum Lim
Fenton McDonald
H. Mendenhall
Marlyn Miner
Timothy P. Monaghan
Brian Morrison
Robert Naville

Peter Onufryk
Michael Orlovsky
Mira Pauker
Philip K. Piele
Rochit Rajsuman
Brian Ramelson
Frederick Sauer
Don Senzig
Patricia Smith
Vincent Squitieri
Benjamin Stoppe, Jr.
Daniel Tarrant
Joseph Toy
Robert Tripi
Robert Voigt
Clarence M. Weaver
Andrew Wilson
J. Robert Wood
David L. Wright
Oren Yuen

When the IEEE Standards Board approved this standard on June 17, 1993, it had the following membership:

Wallace S. Read, Chair

Donald C. Loughry, Vice Chair

Andrew G. Salem, Secretary

Gilles A. Baril
José A. Berrios de la Paz
Clyde R. Camp
Donald C. Fleckenstein
Jay Forster*
David F. Franklin
Ramiro Garcia
Donald N. Heirman

Jim Isaak
Ben C. Johnson
Walter J. Karplus
Lorraine C. Kevra
E. G. "Al" Kiener
Ivor N. Knight
Joseph L. Koepfinger*
D. N. "Jim" Logothetis

Don T. Michael*
Marco W. Migliaro
L. John Rankine
Arthur K. Reilly
Ronald H. Reimer
Gary S. Robinson
Leonard L. Tripp
Donald W. Zipse

*Member Emeritus

Also included are the following nonvoting IEEE Standards Board liaisons:

Satish K. Aggarwal
James Beall
Richard B. Engelman
David E. Soffrin
Stanley I. Warshaw

Rochelle L. Stern
IEEE Standards Project Editor

IEEE Std 896.5-1993 was approved by the American National Standards Institute on November 24, 1993.

Contents

CLAUSE	PAGE
1. Overview.....	1
1.1 Scope.....	1
1.2 Applicability	2
2. Normative references	2
3. Definitions.....	4
3.1 Special word usage	4
3.2 General definitions.....	4
4. Military Profile MIL-12SU.....	8
4.1 Reference specification.....	8
4.2 Logical layer detailed specifications.....	13
4.3 Bus and node management	20
4.4 Physical layer detailed specification.....	32
4.5 Environmental.....	71
4.6 Systems configuration guide.....	72
4.7 Conformance testing	72
5. Military Profile MIL-10SU.....	73
5.1 Reference specification.....	73
5.2 Logical layer detailed specification	79
5.3 Bus and node management	81
5.4 Physical layer detailed specification.....	81
5.5 Environmental.....	106
5.6 Systems configuration guide.....	108
5.7 Conformance testing	108
6. Military Profile MIL-Format E.....	109
6.1 Reference specification.....	109
6.2 Logical layer detailed specification	115
6.3 Bus and node management	116
6.4 Physical layer detailed specification.....	116
6.5 Environmental.....	138
6.6 System configuration guide	139
6.7 Conformance testing	139
 ANNEXES	
Annex A (normative) Military-specific standard units	141
Annex B (informative) Modular open architecture overview	169
Annex C (informative) Current per connector pin guidelines.....	183
Annex D (informative) Example ROM entries for a MIL profile module.....	187
Annex E (informative) Bibliography	195

This page intentionally left blank

Withdrawing

Information technology—Microprocessor systems—Futurebus+™, Profile M (Military)

1. Overview

1.1 Scope

The initial work in development of the Futurebus+™ specification was done under the auspices of the IEEE Computer Society Microprocessor Standards Committee. In 1988, both the United States Navy's Next Generation Computer Resources (NGCR) Backplane Standards Committee and the VFEA International Trade Association (VITA), a trade association of both VME64 manufacturers and users, agreed to join the IEEE in revising ISO/IEC 10857:1994 [ANSI/IEEE Std 896.1, 1994 Edition].¹ In early 1989, the Multibus Manufacturers Group (MMG), a trade association of both Multibus I and Multibus II manufacturers and users, also agreed to join this effort.

The primary goal of all four groups (IEEE, U.S. Navy, VITA, and MMG) was to provide a new microprocessor bus standard that would be commercially viable and that would be acceptable to the two manufacturer groups and the three user communities.

This work resulted in the IEEE 896 family of standards, of which two have become International Standards. ISO/IEC 10857:1994 defines the logical functionality of the set of signals that make up the bus. IEEE Std 896.2-1991 describes and specifies the physical layer (i.e., electrical characteristics, pinouts, connector locations, module sizes, etc.) required. It also contains the first three application environment profiles. IEEE Std 896.3-1993 describes Futurebus+ recommended practices and specifies system-level concerns when using a Futurebus+ backplane in the design of a system. IEEE Std 896.4-1993 describes conformance test requirements for Futurebus+. IEEE Std 896.9-1994 [B3]² defines extensions to the base Futurebus+ standards that are used in extremely fault-tolerant systems. This International Standard describes and specifies the physical layer required for harsh environments that require rugged, fault-tolerant, survivable systems, as in military applications. The three profiles in this International Standard describe functional requirements with pointers to existing standards that select and bind options within those standards. It is these profiles, not the component standards, to which manufacturers may claim conformance. An end user who then purchases modules complying to a given profile from a range of suppliers has a higher assurance of interoperability.

Three physical form factors are incorporated into the military profiles included in this International Standard at the time of publication. Additional profiles that address other aspects of the Futurebus+ computer spectrum are being developed by the working group. These will appear in companion standards. As new physical

¹Information on references can be found in clause 2.

²The numbers in brackets preceded by the letter B correspond to those of the bibliography in annex E.

or electrical layer requirements (e.g., a different connector type or driver technology) emerge, new profiles will be developed to address the enhanced capabilities available from newer technologies; this is part of the reason for layering the Futurebus+ standards.

The scope of this International Standard has been restricted to exclude some of the higher level system requirements associated with bus-based computer systems. These are addressed in companion standards such as IEEE Std 896.3-1993, IEEE Std 896.4-1993, and IEEE Std 896.9-1994 [B3]. The software interface to common-node capabilities as shared by Futurebus+ and Serial Bus (IEEE P1394) is defined by ISO/IEC 13213:1994. This interface provides the framework for defining processor, memory, and I/O nodes on the Futurebus+, as well as bridges to other buses (see IEEE P1014.1 [B4]).

1.2 Applicability

This interface International Standard establishes a modular open architecture for military mission critical systems that employ digital computers, processors, and other electronic modules. This International Standard provides for integration and interoperability of diverse sets of electronic and computer modules for the purpose of configuring various types of computer systems, command/control systems, communications systems and/or weapon systems. This International Standard specifies the electrical, protocol, mechanical, thermal, and input/output interfaces necessary to allow modules, developed to this International Standard, to operate together in an integrated system or subsystem. Where necessary for module interoperability, portions of cabinet or rack interfaces dealing with the mounting of modules and their thermal interfaces are also specified. This common interface International Standard allows development of cost effective, reliable, maintainable, and highly available systems and subsystems. Because the various military systems have differing requirements, multiple form factors for different “lines” of modules are specified herein.

2. Normative references

The following standards contain provisions that, through references in this text, constitute provisions of this International Standard. At the time of publication, the editions indicated were valid. All standards are subject to revision, and parties to agreements based on this International Standard are encouraged to investigate the possibility of applying the most recent editions of the standards listed below. Members of IEC and ISO maintain registers of currently valid International Standards.

IEEE Std 896.2-1991, IEEE Standard for Futurebus+™—Physical Layer and Profile Specification (ANSI).³

IEEE Std 896.2a-1994, IEEE Standard for Futurebus+™—Physical Layer and Profile Specification: Errata, Corrections, and Clarifications.

IEEE Std 896.3-1993, IEEE Recommended Practices for Futurebus+™ (ANSI).

IEEE Std 896.4-1993, IEEE Standard for Conformance Test Requirements for Futurebus+™ (ANSI).

IEEE P896.4a, Draft Standard Supplement to IEEE Standard for Conformance Test Requirements for Futurebus+™—Errata, Corrections, and Clarifications. D1.0/June 20, 1995.⁴

IEEE Std 1101.3-1993, IEEE Mechanical Standard for Conduction-Cooled and Air-Cooled 10SU Modules (ANSI).

³IEEE publications are available from the Institute of Electrical and Electronics Engineers, 445 Hoes Lane, P.O. Box 1331, Piscataway, NJ 08855-1331, USA.

⁴Authorized standards projects, indicated by a P, were not approved by the IEEE Standards Board at the time this standard went to press. They are available from the IEEE.

FUTUREBUS+, PROFILE M (MILITARY)

ISO/IEC 14536 : 1995 (E)
[ANSI/IEEE Std 896.5, 1995 Edition]

IEEE Std 1101.4-1993, IEEE Standard for Military Modules, Format E Form Factor (ANSI).

IEEE P1101.5, Draft Standard Mechanical Interface for a Military Module, Air-Flow-Through-Cooled, Format E Form Factor, D1.2/Mar. 2, 1995.

IEEE P1101.6, Draft Standard Mechanical Interface for an Air-Flow-Through-Cooled Module, 10SU Form Factor, D1.0/Oct. 20, 1993.

IEEE P1101.8, Draft Standard for Information Technology—Mechanical Interface for Liquid-Flow-Through-Cooled Electronic Printed Wiring Assemblies, 10SU, D1.0/Oct. 1993.

IEEE P1101.9, Draft Standard for Information Technology—Mechanical Interface for Liquid-Flow-Through-Cooled Electronic Printed Wiring Assemblies, Format E (396-pin connector only), D2.0/Dec. 7, 1994.

IEEE Std 1156.1-1993, IEEE Standard for Microcomputer Environmental Specifications for Computer Modules (ANSI).

IEEE Std 1194.1-1991, IEEE Standard Electrical Characteristics of Backplane Transceiver Logic (BTL) Interface Circuits (ANSI).

IEEE Std 1212.1-1993, IEEE Standard for Communicating Among Processors and Peripherals Using Shared Memory (Direct Memory Access —DMA) (ANSI).

IEEE Std 1275-1994, IEEE Standard for Boot (Initialization Configuration) Firmware: Core Requirements and Practices (ANSI).

IEEE Std 1275.4-1995, IEEE Standard for Boot (Initialization Configuration) Firmware: Bus Supplement for IEEE 896 (Futurebus+™).

IEEE Std 1301-1991, IEEE Standard for a Metric Equipment Practice for Microcomputers—Coordination Document (ANSI).

IEEE Std 1301.1-1991, IEEE Standard for a Metric Equipment Practice for Microcomputers—Convection-Cooled with 2 mm Connectors (ANSI).

IEEE P1394, Draft Standard for a High Performance Serial Bus. D7.1/Aug. 1994.

ISO/IEC 10857 : 1994 [ANSI/IEEE Std 896.1, 1994 Edition], Information technology—Microprocessor systems—Futurebus+—Logical protocol specification.⁵

ISO/IEC 13213 : 1994 [ANSI/IEEE Std 1212, 1994 Edition], Information technology—Microprocessor systems—Control and Status Register (CSR) Architecture for microcomputer buses.

MIL-HNBK-217, Reliability of Electronic Equipment.⁶

NAVSEA TE000-AB-GTP-010, Parts Application and Reliability Information Manual for Navy Electronic Equipment.⁷

⁵ISO/IEC publications are available from ISO, Case Postale 56, 1 rue de Varembe, CH-1211, Genève 20, Switzerland/Suisse. ISO/IEC [ANSI/IEEE] publications are also available from the Institute of Electrical and Electronics Engineers, 445 Hoes Lane, P.O. Box 1331, Piscataway, NJ 08855-1331, USA.

⁶MIL and NAVSEA publications are available from the Director, U.S. Navy Publications and Printing Service, Eastern Division, 700 Robbins Avenue, Philadelphia, PA 19111, USA.

⁷See footnote 6.